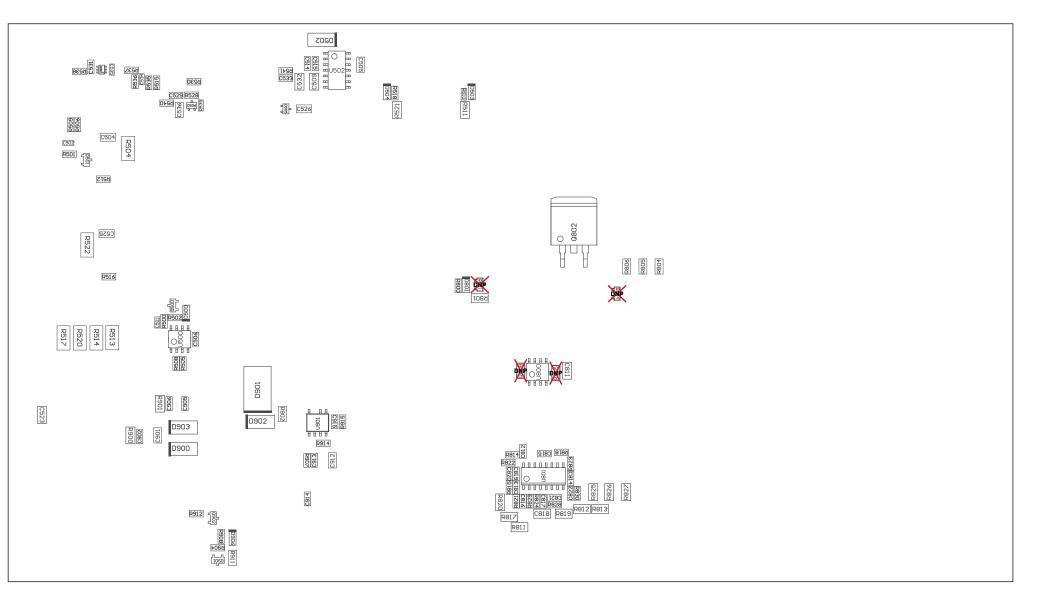


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP11064	REV: B	SUN REU	: Not In VersionControl		
	TID #:					
PLOT NAME = Top Assembly Drawing	GENERATED : 9/22/2	2015 11:13:36	AM	TEXAS INSTRUMENTS		



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP11064	REV: B	SUN REV	: Not In VersionControl		
	TID #:					
PLOT NAME = Bottom Assembly Drawing	GENERATED : 9/22/2	2015 11:13:38	AM	TEXAS INSTRUMENTS		

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